

**SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER**
**Features**

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- High Conductance
- **Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 3 and 4)**
- **Qualified to AEC-Q101 Standards for High Reliability**

**Mechanical Data**

- Case: SOD-323
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe). Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.004 grams (approximate)



Top View

**Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.  
 For capacitance load, derate current by 20%.

| Characteristic                                                                                      | Symbol                                                 | Value | Unit |
|-----------------------------------------------------------------------------------------------------|--------------------------------------------------------|-------|------|
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage              | V <sub>RRM</sub><br>V <sub>RWM</sub><br>V <sub>R</sub> | 30    | V    |
| RMS Reverse Voltage                                                                                 | V <sub>R(RMS)</sub>                                    | 21    | V    |
| Average Rectified Output Current (See Figure 1)                                                     | I <sub>O</sub>                                         | 0.5   | A    |
| Peak Repetitive Forward Current tp = 8.3ms, half sine-wave                                          | I <sub>FRM</sub>                                       | 3.5   | A    |
| Non-Repetitive Peak Forward Surge Current<br>8.3ms single half sine-wave superimposed on rated load | I <sub>FSM</sub>                                       | 2     | A    |

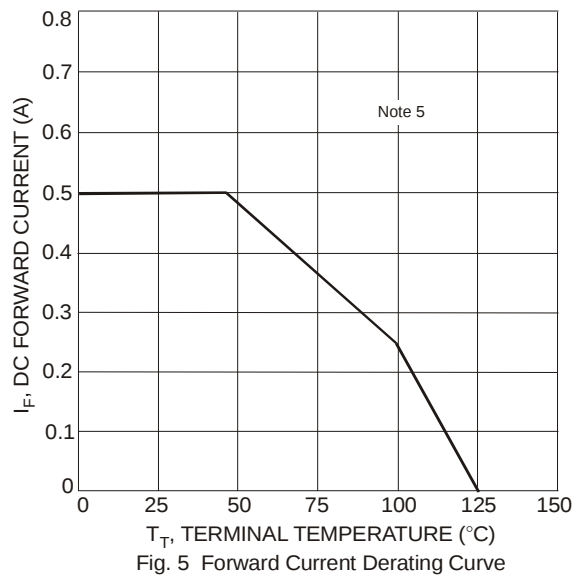
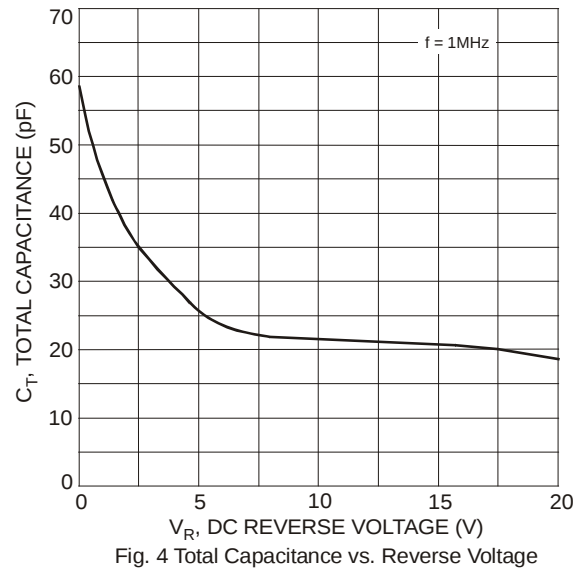
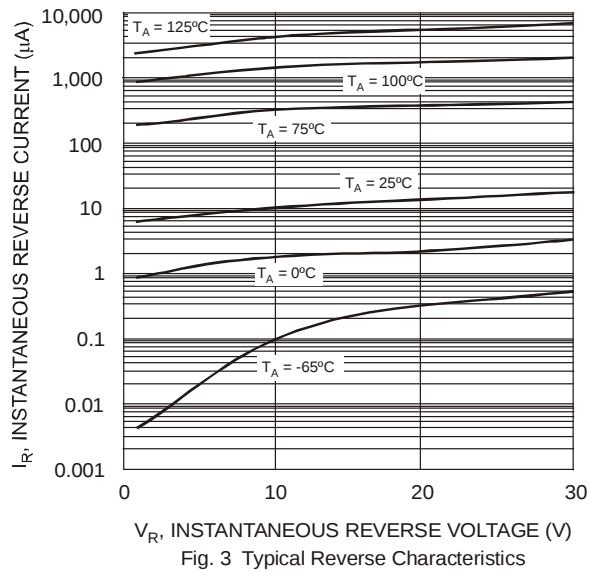
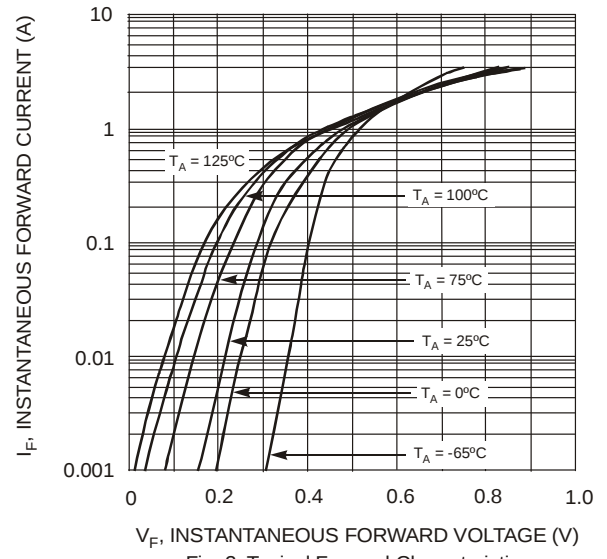
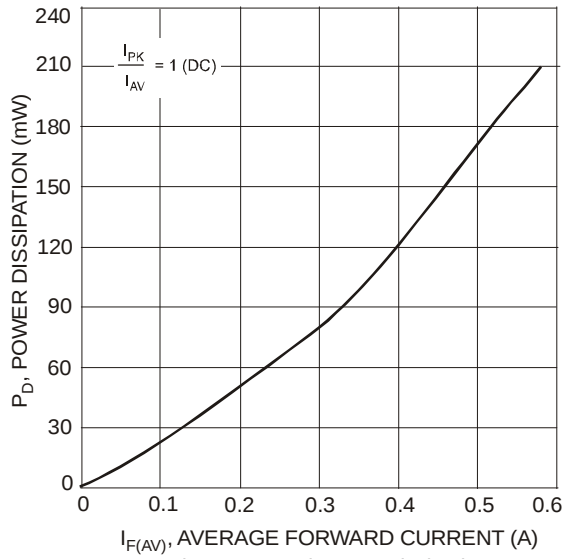
**Thermal Characteristics**

| Characteristic                                          | Symbol                            | Value       | Unit |
|---------------------------------------------------------|-----------------------------------|-------------|------|
| Power Dissipation (Note 1)                              | P <sub>D</sub>                    | 235         | mW   |
| Typical Thermal Resistance Junction to Ambient (Note 1) | R <sub>θJA</sub>                  | 426         | °C/W |
| Operating and Storage Temperature Range                 | T <sub>J</sub> , T <sub>STG</sub> | -40 to +125 | °C   |

**Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

| Characteristic                     | Symbol             | Min | Typ       | Max              | Unit | Test Conditions                                                      |
|------------------------------------|--------------------|-----|-----------|------------------|------|----------------------------------------------------------------------|
| Reverse Breakdown Voltage (Note 2) | V <sub>(BR)R</sub> | 30  | —         | —                | V    | I <sub>R</sub> = 500μA                                               |
| Forward Voltage Drop               | V <sub>F</sub>     | —   | —<br>0.40 | 0.36<br>0.45     | V    | I <sub>F</sub> = 0.1A<br>I <sub>F</sub> = 0.5A                       |
| Leakage Current (Note 2)           | I <sub>R</sub>     | —   | —         | 80<br>100<br>500 | μA   | V <sub>R</sub> = 15V<br>V <sub>R</sub> = 20V<br>V <sub>R</sub> = 30V |
| Total Capacitance                  | C <sub>T</sub>     | —   | 58        | —                | pF   | f = 1MHz, V <sub>R</sub> = 0V DC                                     |

- Notes:
1. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
  2. Short duration pulse test used to minimize self-heating effect.
  3. No purposefully added lead. Halogen and Antimony Free.
  4. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.



## Ordering Information (Note 6)

| Part Number | Case    | Packaging        |
|-------------|---------|------------------|
| B0530WS-7-F | SOD-323 | 3000/Tape & Reel |

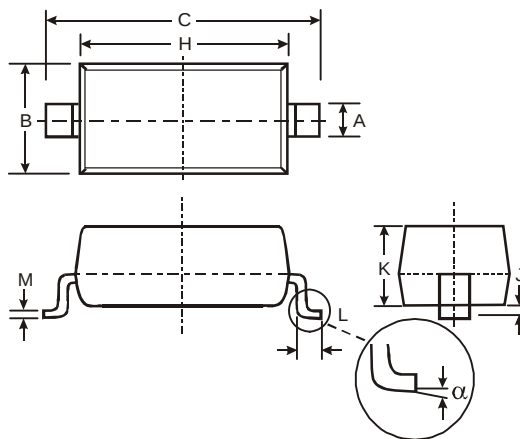
Notes: 6. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

## Marking Information



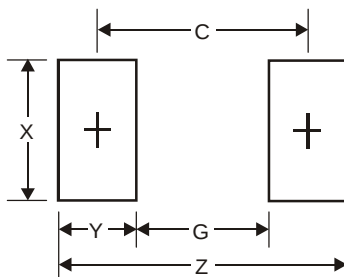
SE = Product Type Marking Code

## Package Outline Dimensions



| SOD-323              |      |      |
|----------------------|------|------|
| Dim                  | Min  | Max  |
| A                    | 0.25 | 0.35 |
| B                    | 1.20 | 1.40 |
| C                    | 2.30 | 2.70 |
| H                    | 1.60 | 1.80 |
| J                    | 0.00 | 0.10 |
| K                    | 1.0  | 1.1  |
| L                    | 0.20 | 0.40 |
| M                    | 0.10 | 0.15 |
| $\alpha$             | 0°   | 8°   |
| All Dimensions in mm |      |      |

## Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z          | 3.75          |
| G          | 1.05          |
| X          | 0.65          |
| Y          | 1.35          |
| C          | 2.40          |

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